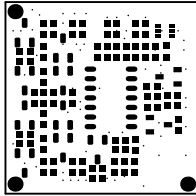
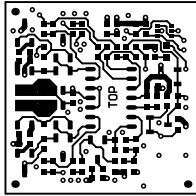


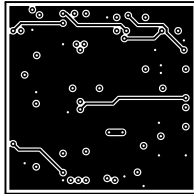
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01527		
PLOT NAME = Top Overlay	GENERATED : 09-Dec-17 2:28:23 PM		TEXAS INSTRUMENTS



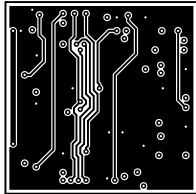
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01527		
PLOT NAME = Top Solder Mask	GENERATED : 09-Dec-17 2:28:24 PM		TEXAS INSTRUMENTS



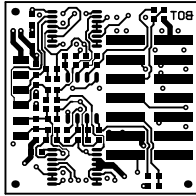
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01527		
PLOT NAME = Top Layer	GENERATED : 09-Dec-17 2:28:25 PM	TEXAS INSTRUMENTS	



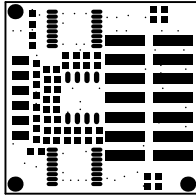
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01527		
PLOT NAME = Signal Layer 1	GENERATED : 09-Dec-17 2:28:26 PM		TEXAS INSTRUMENTS



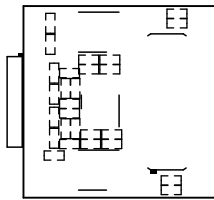
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01527		
PLOT NAME = Signal Layer 2	GENERATED : 09-Dec-17 2:28:27 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SUN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01527		
PLOT NAME = Bottom Layer	GENERATED : 09-Dec-17 2:28:27 PM		TEXAS INSTRUMENTS



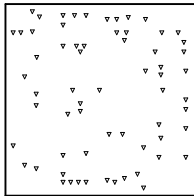
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME =	TID #: TIDA-01527		
PLOT NAME = Bottom Solder Mask	GENERATED : 09-Dec-17 2:28:28 PM		TEXAS INSTRUMENTS



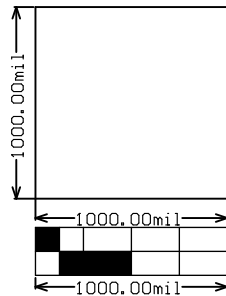
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01527		
PLOT NAME = Bottom Overlay	GENERATED : 09-Dec-17 2:28:29 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
▽	64	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
	64 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01527		
PLOT NAME = Drill Drawing	GENERATED : 09-Dec-17 2:28:30 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01527	REV: E2	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01527		
PLOT NAME = Board Dimensions	GENERATED : 09-Dec-17 2:28:31 PM		TEXAS INSTRUMENTS

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